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☐☐	POM
MOQ	100☐
☐☐	3☐

**POM**☐☐



**SFENG**  
The China's The World's





## 产品特点

1. 绝缘性好
2. 耐高温
3. 耐腐蚀
4. 强度高

## 应用

PCB、ICT、FCT 等应用领域

广泛应用于汽车电子、工业控制、医疗设备、航空航天等领域

BGA 封装等应用领域

主要产品包括：LM、QZ、VZ 等系列

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1. Raw material warehouse



2. Lathe workshop



3. Assemble workshop



4. Quality inspection



5. Finished products

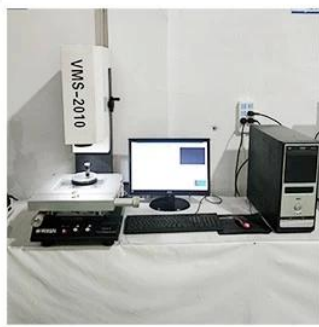


6. Packing

□□□□



1. Agilent current testing



2. Quadratic element



3. Load Curve Meter



4. Bond Test



5. Life Fatigue Test



6. Microscope



Standard products will be delivered out within 3 days. Customized products will be sent out within 15 days.

